# THE DATASHEET OF

# SPHWHAHDNF27YZV3J0

# High Voltage LED Series
# Chip on Board

# LC019D – Gen.1

## High efficacy COB LED package
## well-suited for use in spotlight applications

### Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

### Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination

SAMSUNG

# Table of Contents

# 1. Characteristics

## a) Absolute Maximum Rating

| Item | Symbol | Rating | Unit | Condition |
|---|---|---|---|---|
| Ambient / Operating Temperature | $T_a$ | -40 ~ +105 | ºC | - |
| Storage Temperature | $T_{stg}$ | -40 ~ +120 | ºC | - |
| LED Junction Temperature | $T_J$ | 140 | ºC | - |
| Case Temperature | Tc | 105 | ºC | |
| Forward Current | $I_F$ | 1380 | mA | - |
| Power Dissipation | $P_D$ | 51.8 | W | - |
| ESD (HBM) | - | ±2 | kV | - |
| ESD (MM) | - | ±0.5 | kV | - |

## b) Electro-optical Characteristics ($I_F$ = 540 mA, $T_J$ = 85 ºC)

| Item | Unit | Rank | Min. | Typ. | Max. |
|---|---|---|---|---|---|
| Forward Voltage ($V_F$) | V | YZ | 31.8 | 34.6 | 37.5 |
| Color Rendering Index ($R_a$) | - | 5 | 80 | - | - |
| | | 7 | 90 | | |
| Thermal Resistance (junction to chip point) | ºC/W | | - | 1.0 | - |
| Beam Angle | º | | - | 115 | - |
| Nominal Power | W | | | 20.3 | |

**Notes:**

1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ($T_J$ = $T_C$ = $T_a$ = 85 °C)
2) Samsung maintains measurement tolerance of: forward voltage = ±5 %, CRI = ±1
3) Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range.

## c) Luminous Flux Characteristics ($I_F$ = 540 mA)

| CRI ($R_a$) Min. | Nominal CCT (K) | Flux Rank | Flux @ $T_J$ = 85 °C (lm) | | |
|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. |
| 80 | 2700 | J3 | 2335 | 2458 | - |
| | | D1 | 2458 | 2581 | - |
| | 3000 | J4 | 2462 | 2592 | - |
| | | D1 | 2592 | 2722 | - |
| | 3500 | J5 | 2538 | 2672 | - |
| | | D1 | 2672 | 2805 | - |
| | 4000 | J5 | 2590 | 2726 | - |
| | | D1 | 2726 | 2863 | - |
| | 5000 | J6 | 2618 | 2756 | - |
| | | D1 | 2756 | 2894 | - |
| | 5700 | J6 | 2618 | 2756 | - |
| | | D1 | 2756 | 2894 | - |
| | 6500 | J5 | 2590 | 2726 | - |
| | | D1 | 2726 | 2863 | - |

| CRI ($R_a$) Min. | Nominal CCT (K) | Flux Rank | Flux @ $T_J$ = 85 °C (lm) | | |
|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. |
| 90 | 2700 | H9 | 1999 | 2104 | - |
| | | D1 | 2104 | 2210 | - |
| | 3000 | J0 | 2096 | 2207 | - |
| | | D1 | 2207 | 2317 | - |
| | 3500 | J1 | 2173 | 2287 | - |
| | | D1 | 2287 | 2402 | - |
| | 4000 | J2 | 2220 | 2337 | - |
| | | D1 | 2337 | 2454 | - |
| | 5000 | J2 | 2222 | 2339 | |
| | | D1 | 2339 | 2456 | |

**Notes:**

1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature ($T_J$ = $T_C$ = 85 °C).
2) Samsung maintains measurement tolerance of: Luminous flux = ±7 %, CRI = ±1

## 2. Product Code Information

| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| S | P | H | W | H | A | H | D | N | F | 2 | 5 | Y | Z | W | 3 | J | 3 |

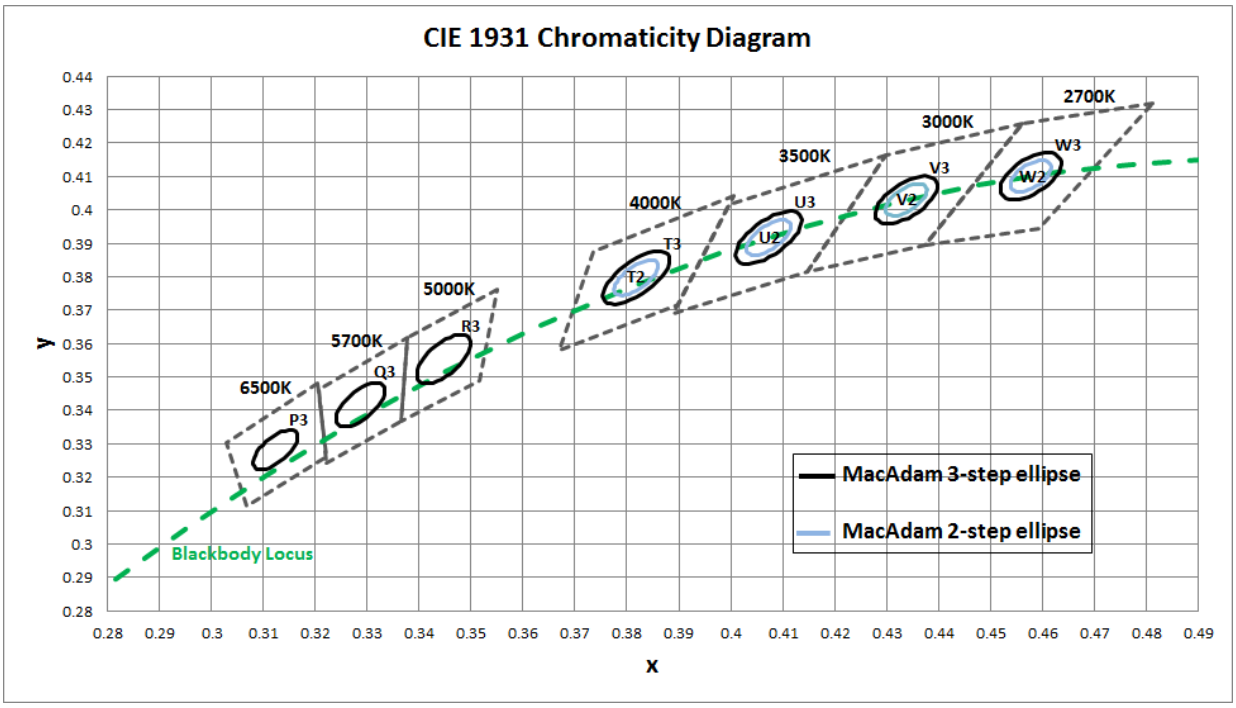
| Digit | PKG Information | Code | Specification |
|---|---|---|---|
| 1 2 3 | Samsung Package High Power | SPH | |
| 4 5 | Color | WH | White |
| 6 | Product Version | A | |
| 7 8 | Form Factor | HD | COB |
| 9 | Lens Type | N | No lens |
| 10 | Wattage or Model | F | LC019D |
| 11 | Internal Code | 2 | |
| 12 | CRI & Sorting Temperature | 5 | Min. 80 (85℃) |
| | | 7 | Min. 90 (85℃) |
| 13 14 | Forward Voltage (V) | YZ | 31.8~37.5 |
| 15 | CCT (K) | W | 2700K |
| | | V | 3000K |
| | | U | 3500K |
| | | T | 4000K |
| | | R | 5000K |
| | | Q | 5700K |
| | | P | 6500K |
| 16 | MacAdam Step | 2 | MacAdam 2-step |
| | | 3 | MacAdam 3-step |
| 17 18 | Luminous Flux | H9 | Min. 1900 |
| | | J0 | Min. 2000 |
| | | J1 | Min. 2100 |
| | | J2 | Min. 2200 |
| | | J3 | Min.2300 |
| | | J4 | Min. 2400 |
| | | J5 | Min. 2500 |
| | | J6 | Min. 2600 |

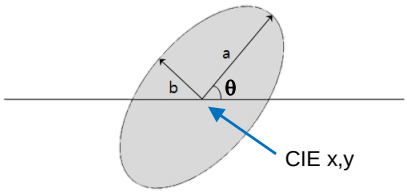
## a) Binning Structure ($I_F$ = 540 mA, $T_J$ = 85 ºC)

| CRI ($R_a$) Min. | Nominal CCT (K) | Product Code | $V_F$ Rank | Color Rank | Flux Rank | Flux Range ($\Phi_v$, lm) |
|---|---|---|---|---|---|---|
| 80 | 2700 | SPHWHAHDNF25YZW2J3 | YZ | W2 | J3 | 2335 ~ |
| | | SPHWHAHDNF25YZW3J3 | | W3 | | |
| | | SPHWHAHDNF25YZW2D1 | | W2 | D1 | 2458 ~ |
| | | SPHWHAHDNF25YZW3D1 | | W3 | | |
| | 3000 | SPHWHAHDNF25YZV24 | YZ | V2 | J4 | 2462 ~ |
| | | SPHWHAHDNF25YZV3J4 | | V3 | | |
| | | SPHWHAHDNF25YZV2D1 | | V2 | D1 | 2592 ~ |
| | | SPHWHAHDNF25YZV3D1 | | V3 | | |
| | 3500 | SPHWHAHDNF25YZU25 | YZ | U2 | J5 | 2538 ~ |
| | | SPHWHAHDNF25YZU3J5 | | U3 | | |
| | | SPHWHAHDNF25YZU2D1 | | U2 | D1 | 2672 ~ |
| | | SPHWHAHDNF25YZU3D1 | | U3 | | |
| | 4000 | SPHWHAHDNF25YZT25 | YZ | T2 | J5 | 2590 ~ |
| | | SPHWHAHDNF25YZT3J5 | | T3 | | |
| | | SPHWHAHDNF25YZT2D1 | | T2 | D1 | 2726 ~ |
| | | SPHWHAHDNF25YZT3D1 | | T3 | | |
| | 5000 | SPHWHAHDNF25YZR3J6 | YZ | R3 | J6 | 2618 ~ |
| | | SPHWHAHDNF25YZR3D1 | | | D1 | 2756 ~ |
| | 5700 | SPHWHAHDNF25YZQ3J6 | YZ | Q3 | J6 | 2618 ~ |
| | | SPHWHAHDNF25YZQ3D1 | | | D1 | 2756 ~ |
| | 6500 | SPHWHAHDNF25YZP3J5 | YZ | P3 | J5 | 2590 ~ |
| | | SPHWHAHDNF25YZP3D1 | | | D1 | 2726 ~ |

| CRI ($R_a$) Min. | Nominal CCT (K) | Product Code | $V_F$ Rank | Color Rank | Flux Rank | Flux Range ($\Phi_v$, lm) |
|---|---|---|---|---|---|---|
| 90 | 2700 | SPHWHAHDNF27YZW2H9 | YZ | W2 | H9 | 1999 ~ |
| | | SPHWHAHDNF27YZW3H9 | | W2 | | |
| | | SPHWHAHDNF27YZW2D1 | | W2 | D1 | 2104 ~ |
| | | SPHWHAHDNF27YZW3D1 | | W2 | | |
| | 3000 | SPHWHAHDNF27YZV2J0 | YZ | V2 | J0 | 2096 ~ |
| | | SPHWHAHDNF27YZV3J0 | | V3 | | |
| | | SPHWHAHDNF27YZV2D1 | | V2 | D1 | 2207 ~ |
| | | SPHWHAHDNF27YZV3D1 | | V3 | | |
| | 3500 | SPHWHAHDNF27YZU2J1 | YZ | U2 | J1 | 2173 ~ |
| | | SPHWHAHDNF27YZU3J1 | | U3 | | |
| | | SPHWHAHDNF27YZU2D1 | | U2 | D1 | 2287 ~ |
| | | SPHWHAHDNF27YZU3D1 | | U3 | | |
| | `4000 | SPHWHAHDNF27YZT2J2 | YZ | T2 | J2 | 2220 ~ |
| | | SPHWHAHDNF27YZT3J2 | | T3 | | |
| | | SPHWHAHDNF27YZT2D1 | | T2 | D1 | 2337 ~ |
| | | SPHWHAHDNF27YZT3D1 | | T3 | | |
| | 5000 | SPHWHAHDNG27YZR3J8 | YZ | R3 | J8 | 2222 ~ |
| | | SPHWHAHDNG27YZR3D1 | | R3 | D1 | 2339 ~ |

## b) Chromaticity Region & Coordinates ($I_F$ = 540 mA, $T_J$ = 85 ºC)




| MacAdam Ellipse (W2, W3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 2-step | 0.4578 | 0.4101 | 53.70 | 0.0054 | 0.0028 |
| 3-step | 0.4578 | 0.4101 | 53.70 | 0.0081 | 0.0042 |

| MacAdam Ellipse (V2, V3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 2-step | 0.4338 | 0.403 | 53.22 | 0.0056 | 0.0027 |
| 3-step | 0.4338 | 0.4030 | 53.22 | 0.0083 | 0.0041 |

| MacAdam Ellipse (U2, U3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 2-step | 0.4073 | 0.3917 | 54.00 | 0.0062 | 0.0028 |
| 3-step | 0.4073 | 0.3917 | 54.00 | 0.0093 | 0.0041 |

| MacAdam Ellipse (T2, T3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 2-step | 0.3818 | 0.3797 | 53.72 | 0.0063 | 0.0027 |
| 3-step | 0.3818 | 0.3797 | 53.72 | 0.0094 | 0.0040 |

| MacAdam Ellipse (R3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 3-step | 0.3447 | 0.3553 | 59.62 | 0.0082 | 0.0035 |

| MacAdam Ellipse (Q3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 3-step | 0.3287 | 0.3417 | 59.0950 | 0.0075 | 0.0032 |

| MacAdam Ellipse (P3) | | | | | |
|---|---|---|---|---|---|
| Step | CIE x | CIE y | θ | a | b |
| 3-step | 0.3123 | 0.3282 | 58.5700 | 0.0067 | 0.0029 |

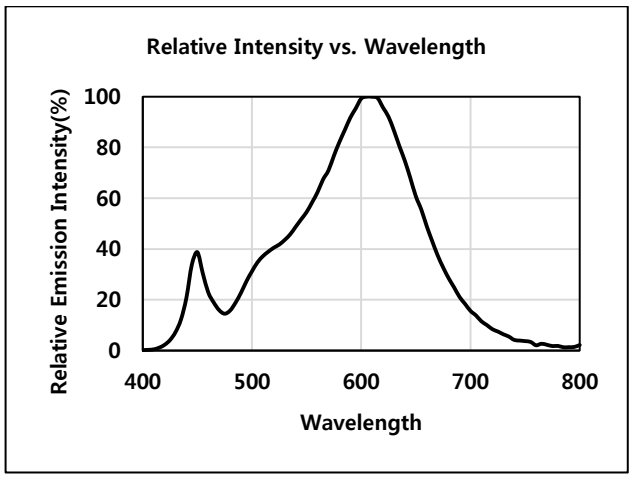
**Note:**

Samsung maintains measurement tolerance of: Cx, Cy = ±0.005

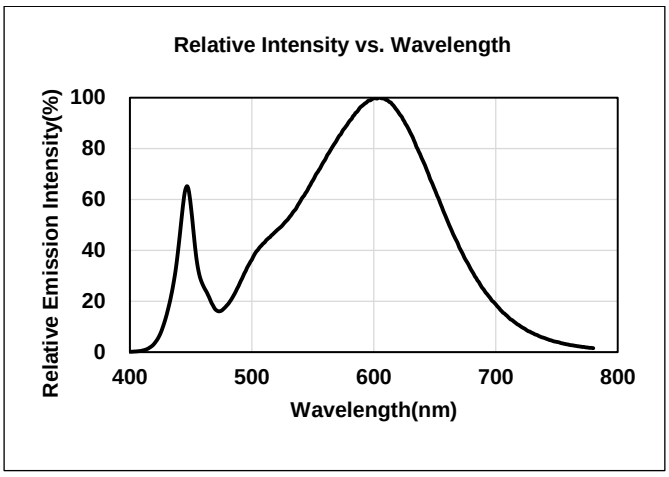
## 3. Typical Characteristics Graphs

### a) Spectrum Distribution ($I_F$ = 540 mA, $T_J$ = 85 ºC)

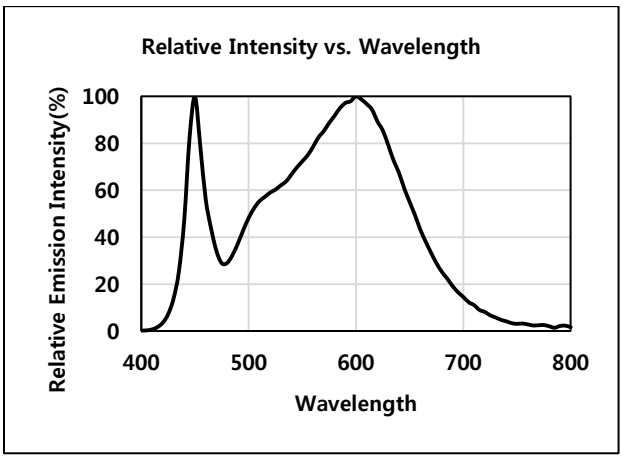
*CCT: 2700 K (80 CRI)*



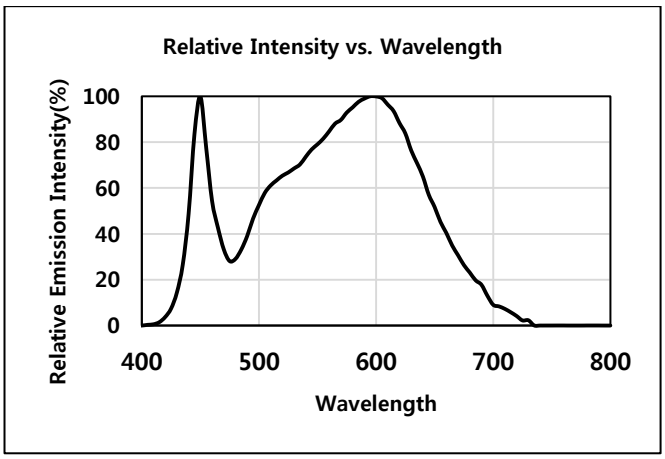

*CCT: 3000 K (80 CRI)*



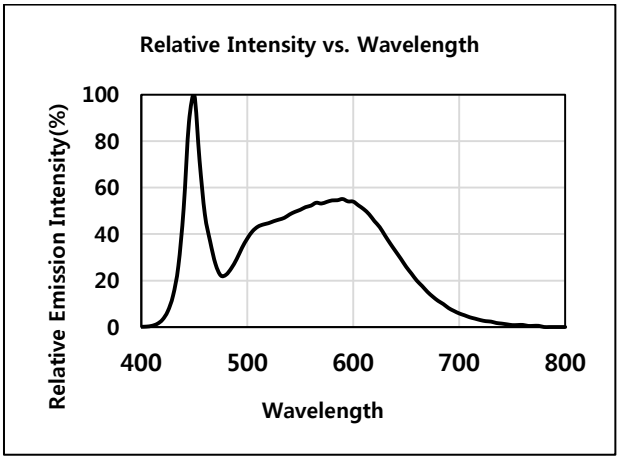

*CCT: 3500 K (80 CRI)*



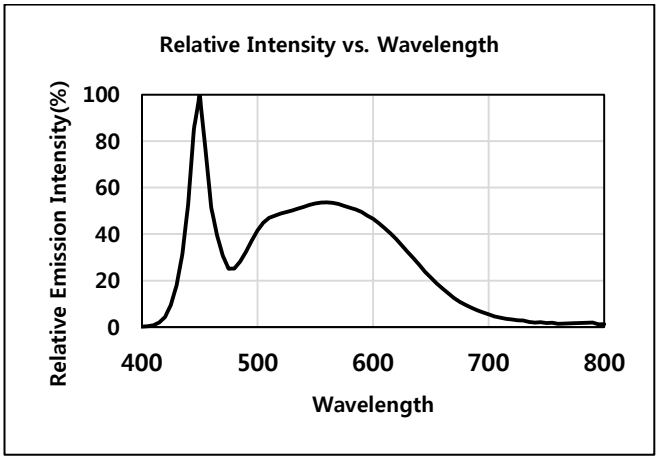

*CCT: 4000 K (80 CRI)*



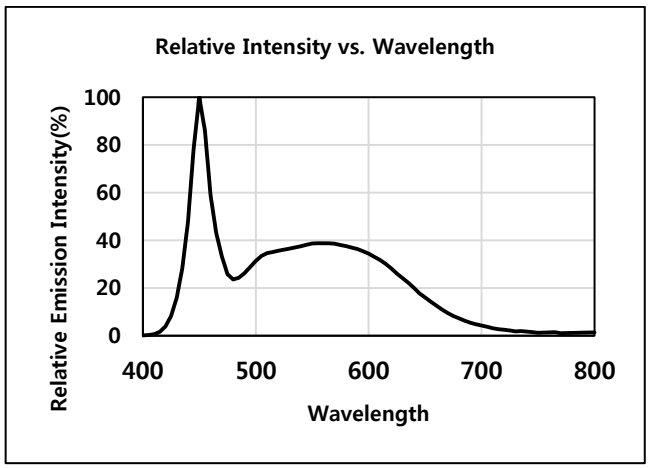

*CCT: 5000 K (80 CRI)*



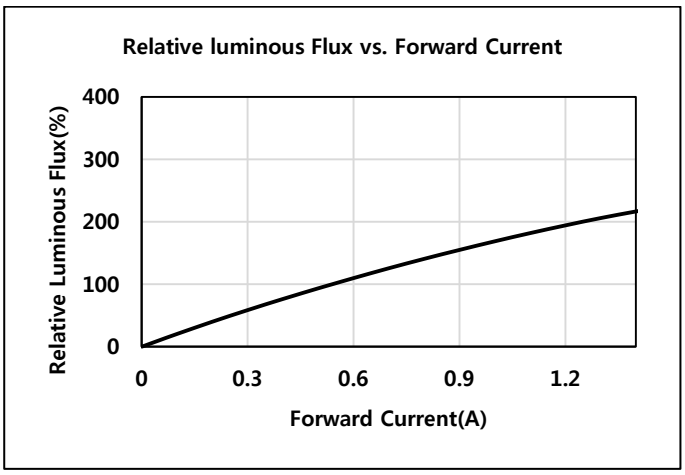

*CCT: 5700 K (80 CRI)*

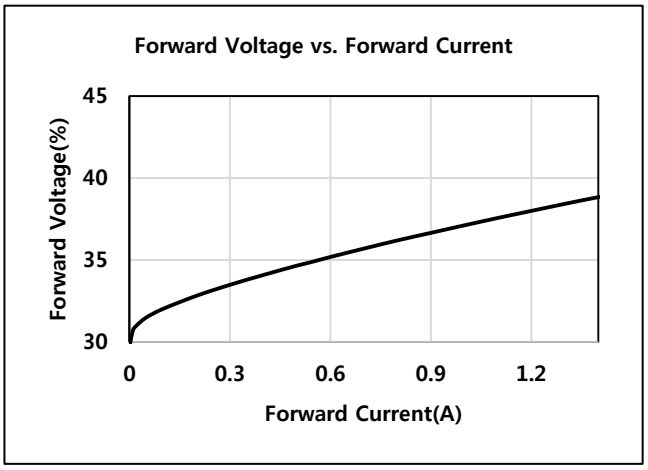


*CCT: 6500 K (80 CRI)*

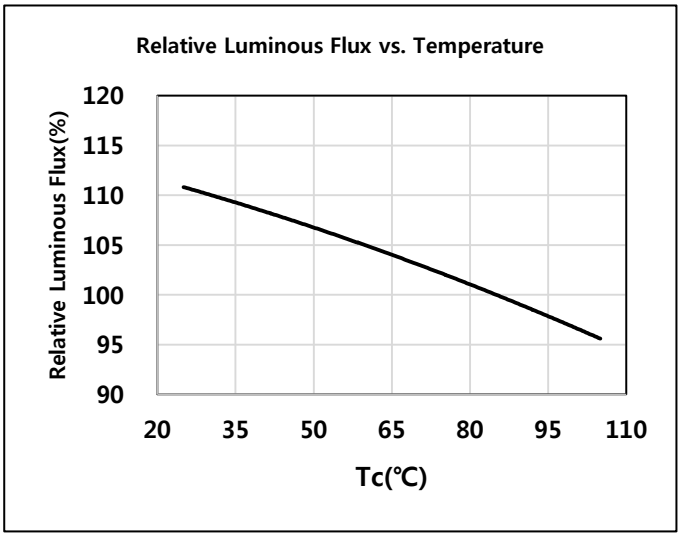


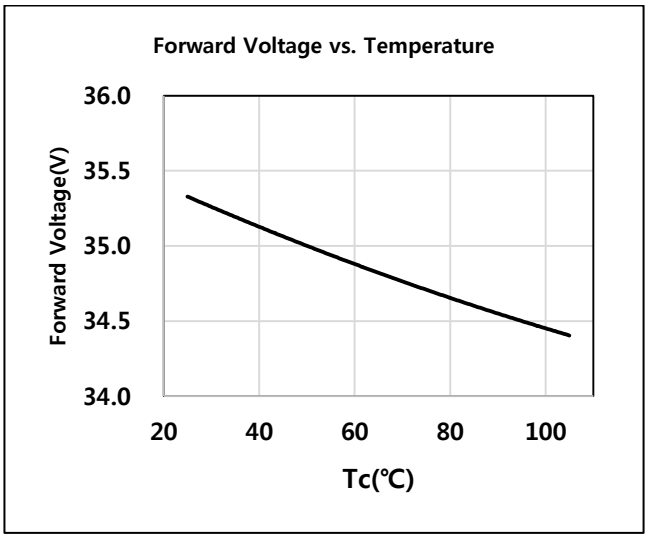

## b) Forward Current Characteristics ($T_J$ = 85 ºC)



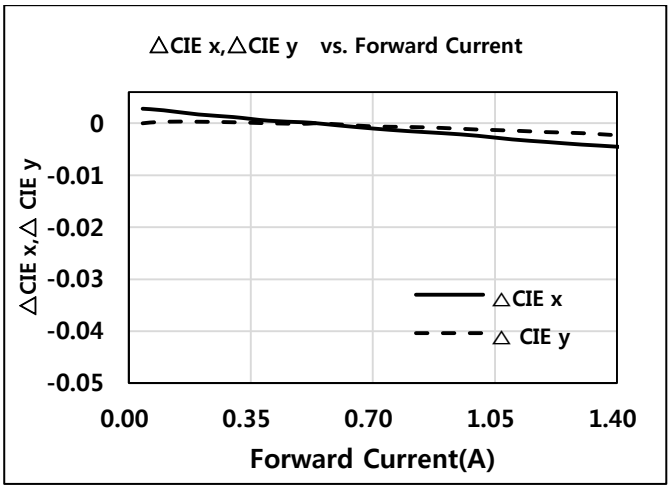



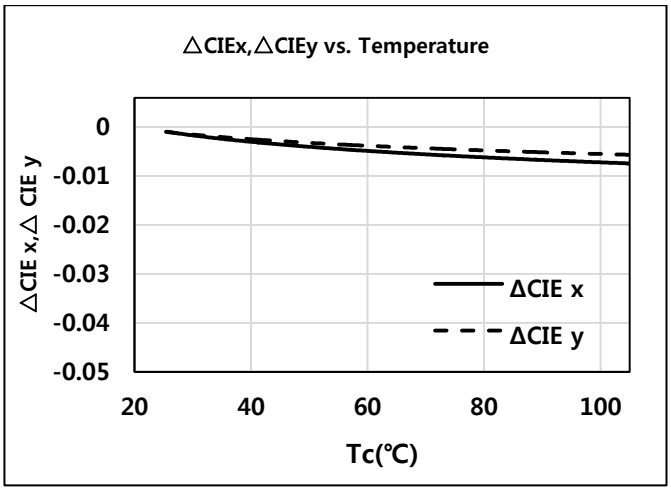

## C) Temperature Characteristics ($I_F$ = 540mA)



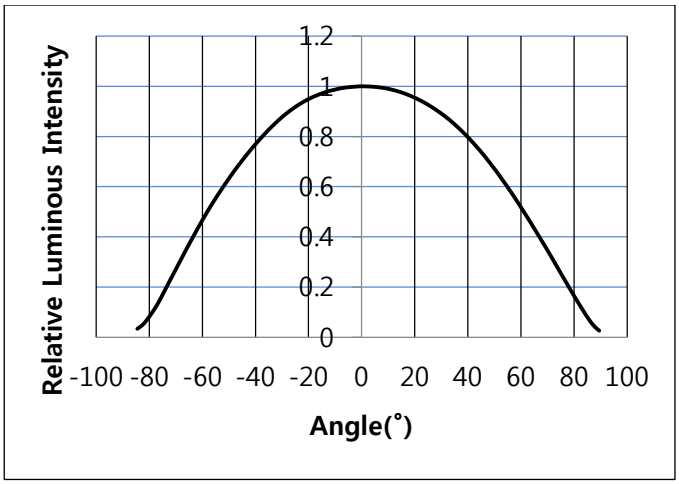



### d) Color Shift Characteristics ($T_J$ = 85 ºC, $I_F$ = 540mA, CRI80+)

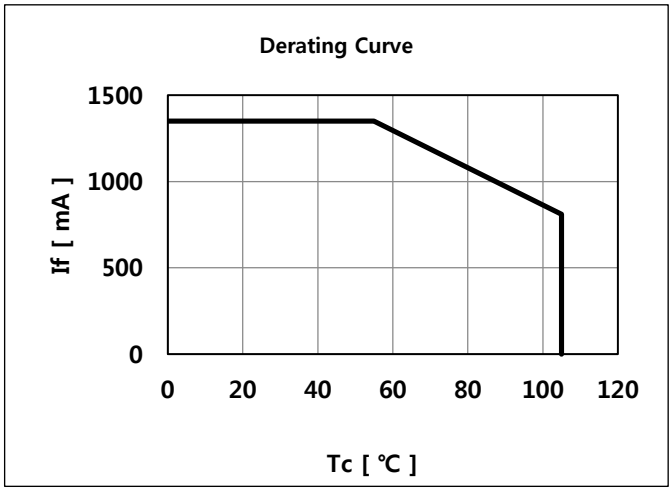


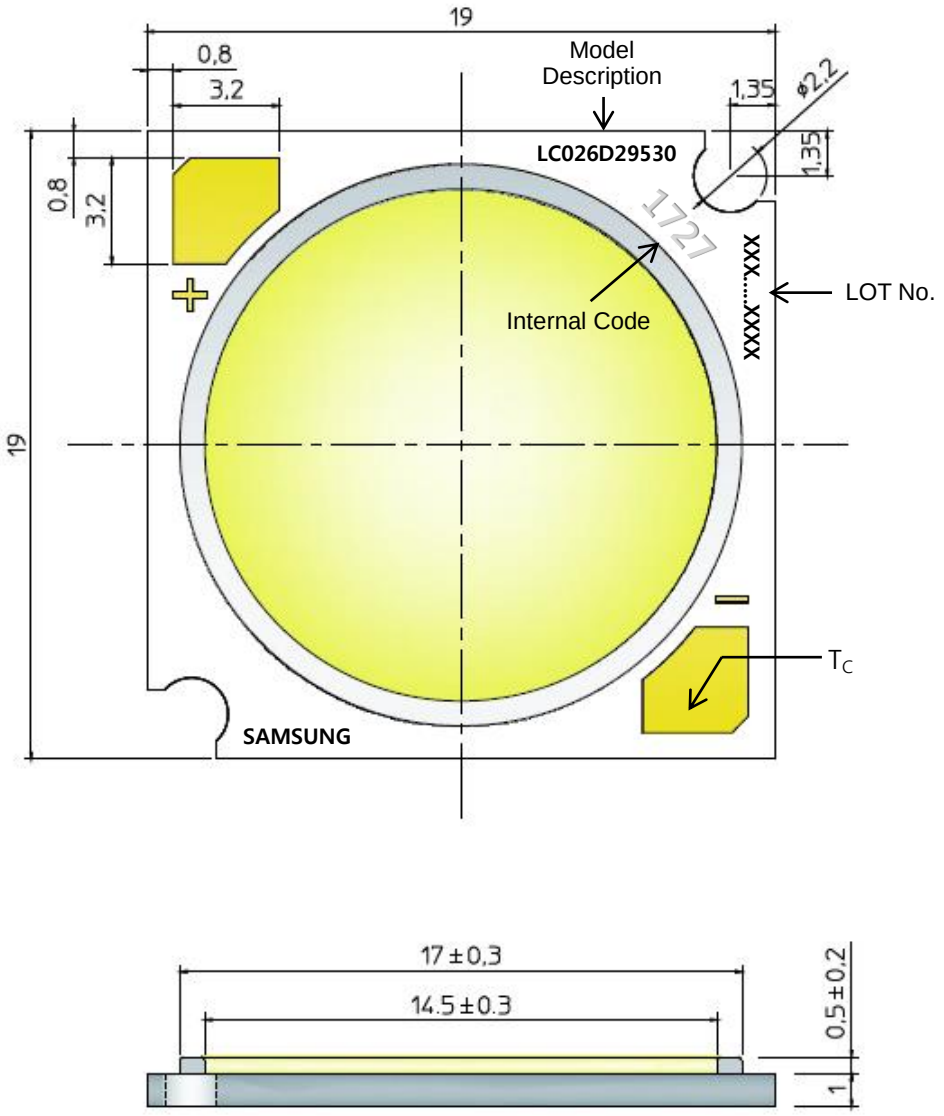

### e) Beam Angle Characteristics ($I_F$ = 540 mA, $T_J$ = 85 ºC)




### f) Derating Characteristics



## 4. Outline Drawing & Dimension




1. Unit: mm
2. Tolerance: ± 0.3 mm

| Item | Dimension | Tolerance | Unit |
|---|---|---|---|
| Length | 19.0 | ±0.15 | mm |
| Width | 19.0 | ±0.15 | mm |
| Height | 1.50 | ±0.30 | mm |
| Light Emitting Surface (LES) Diameter | 14.5 | ±0.30 | mm |

Note: Denoted product information above is only an example
( LC019D18030 : LC019D, CRI80+, 3000K )

# 5. Reliability Test Items & Conditions

## a) Test Items

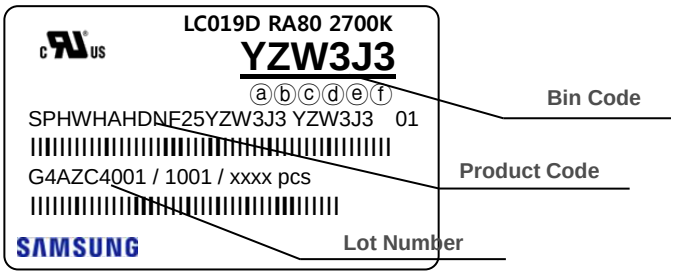
| Test Item | Test Condition | Test Hour / Cycle |
|---|---|---|
| High Temperature Humidity Life Test | 60 ºC, 90 % RH,, DC Derating, $I_F$ | 1000 h |
| High Temperature Life Test | 85 ºC, DC Derating, $I_F$ | 1000 h |
| Low Temperature Life Test | -40 ºC, DC , $I_F$ = 970 mA | 1000 h |
| Pulsed Operating Life Test | 55 ℃, Pulse width 100 μs, duty cycle 3 % | 1000 h |
| High Temperature Storage | 120 ºC | 1000 h |
| Low Temperature Storage | -40 ºC | 1000 h |
| Temperature Humidity Storage | 60 ºC, 90% RH | 1000h |
| Temperature Cycle On/Off Test | -40 ºC / 85 ºC each 20 min, 30 min transfer<br>power on/off each 5 min, DC Derating, $I_F$ = max | 100 cycles |
| ESD (HBM) | $R_1$: 10 MΩ<br>$R_2$: 1.5 kΩ<br>C: 100 pF<br>V: ±2 kV | 5 times |
| ESD (MM) | $R_1$: 10 MΩ<br>$R_2$: 0 kΩ<br>C: 200 pF<br>V: ±0.2 kV | 5 times |
| Vibration Test | 20 ~ 80 Hz (displacement: 0.06 inch, max. 20 g)<br>80 ~ 2 kHz (max. 20 g)<br>min. frequency ↔ max. frequency 4 min transfer | 4 times |
| Mechanical Shock Test | 1500 g, 0.5 ms<br>each of the 6 surfaces (3 axis x 2 sides) | 5 times |
| Sulfur Resistance | 25 °C, 75%, H2S 15 ppm | 504h |

## b) Criteria for Judging the Damage

| Item | Symbol | Test Condition ($T_c$ = 25 ºC) | Limit | |
|---|---|---|---|---|
| | | | Min. | Max. |
| Forward Voltage | $V_F$ | $I_F$ = 540 mA | L.S.L. * 0.9 | U.S.L. * 1.1 |
| Luminous Flux | $\Phi_v$ | $I_F$ = 540 mA | L.S.L * 0.7 | U.S.L * 1.3 |

## 6. Label Structure

### a) Label Structure




Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

ⓐⓑ: Forward Voltage bin (refer to page 11)

ⓒⓓ: Chromaticity bin (refer to page 9-10)

ⓔⓕ: Luminous Flux bin (refer to page 6)

### b) Lot Number

The lot number is composed of the following characters:

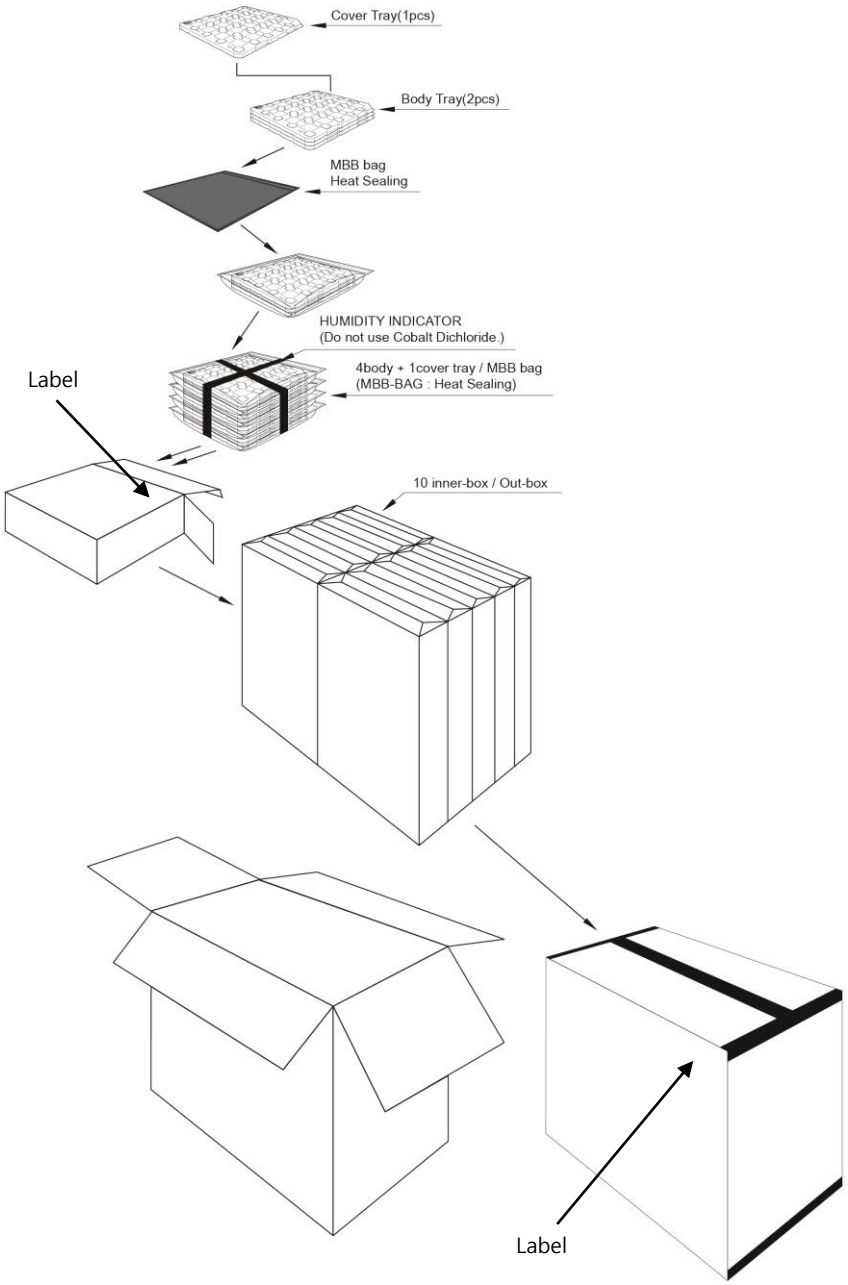

① ③④⑤⑥⑦⑧⑨ / 1ⓐⓑⓒ / xxxx pcs

| | | |
|---|---|---|
| ① | : | Production site (S: Giheung, Korea, G: Tianjin, China) |
| ② | : | 4 (LED) |
| ③ | : | Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample) |
| ④ | : | Year (Z: 2015, A: 2016, B: 2017…) |
| ⑤ | : | Month (1~9, A, B, C) |
| ⑥⑦⑧⑨ | : | Day (1~9, A, B~V) |
| ⓐⓑⓒ | : | Product serial number (001 ~ 999) |

## 6. Packing Structure

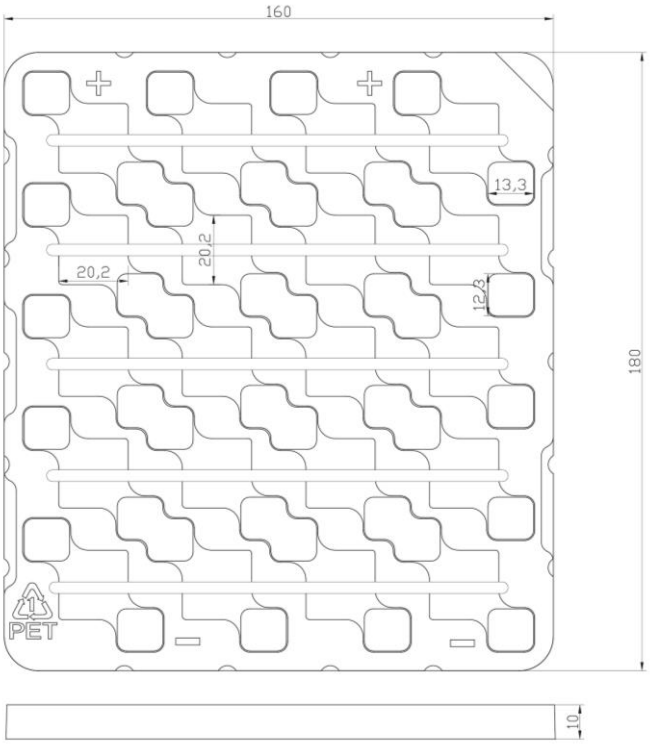
| Packing material | Max. quantity in pcs of COB | Dimension(mm) | | | |
|---|---|---|---|---|---|
| | | Length | Width | Height | Tolerance |
| **Tray** | 20 | 160 | 180 | 10 | 1.0 |
| **Aluminum Bag** | 40(2 trays) | 210 | 241 | | 10 |
| **Inner Box** | 160 | 230 | 84 | 260 | 2 |
| **Outer Box** | 1600 | 476 | 445 | 272 | 5 |

### a) Packing Structure

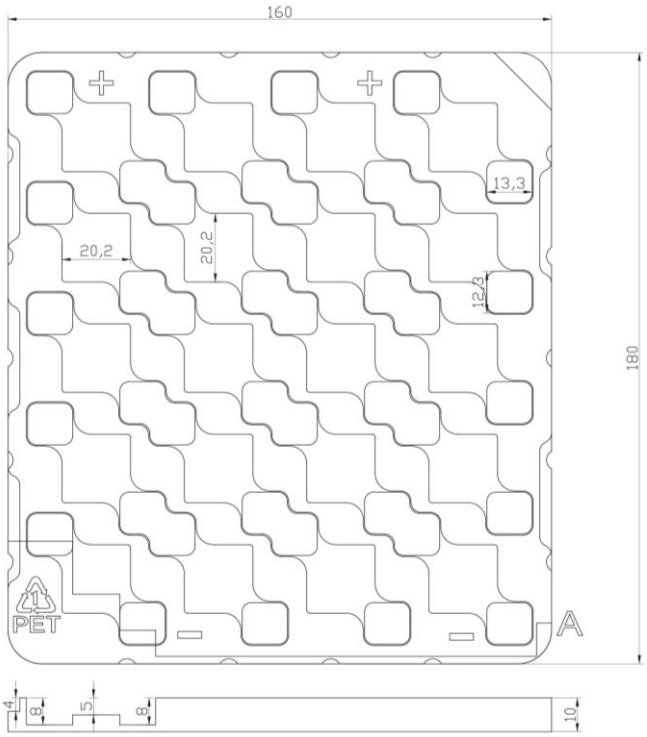


## b) Tray

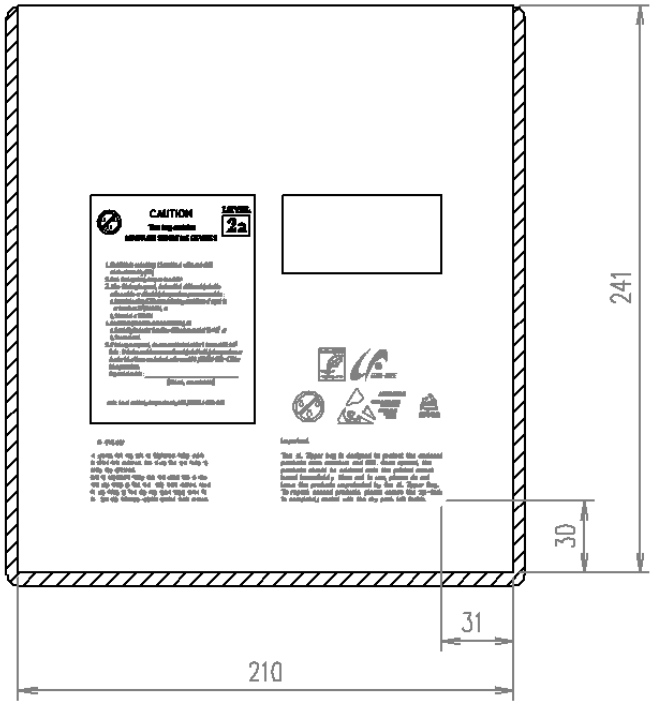
### ① Cover




### ② Body



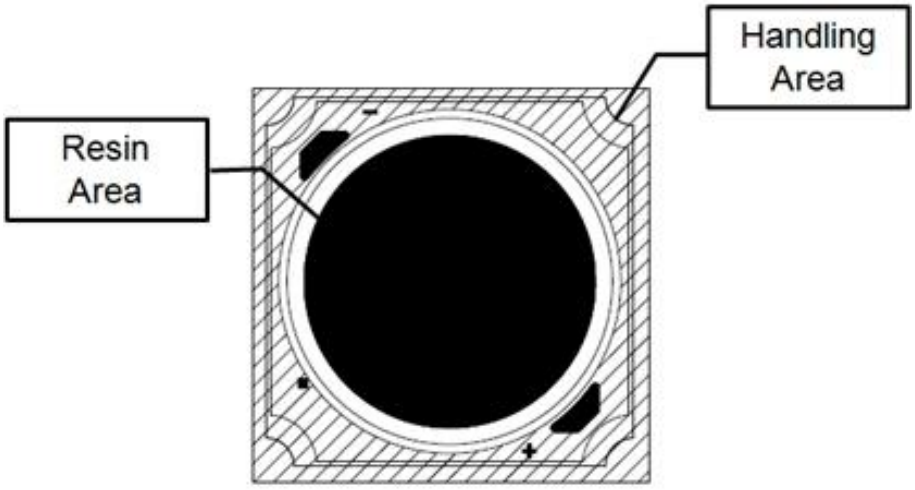

## c) Aluminum Vinyl Packing Bag



## 8. Precautions in Handling & Use

1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 ºC, 0~90 % RH).
3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
   a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 ºC / 60 % RH, or
   b. Stored at <10 % RH
4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
5) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 ºC.
6) Devices must be baked for 1 hour at 60 ± 5 ºC, if baking is required.
7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.

   For more information, please refer to Application Note ‘Mechanical & Thermal Guide for COB’.
9) In case of driving LEDs around the minimum current level (If_min), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



# Legal and additional information.

## About Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies, redefining the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems and semiconductors. We are also leading in the Internet of Things space through, among others, our Digital Health and Smart Home initiatives. We employ 307,000 people across 84 countries. To discover more, please visit our official website at www.samsung.com and our official blog at global.samsungtomorrow.com.



Samsung Electronics Co., Ltd.
95, Samsung 2-ro
Giheung-gu
Yongin-si, Gyeonggi-do, 446-711
KOREA

www.samsungled.com

SAMSUNG

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- View SPHWHAHDNF27YZV3J0 on WIN SOURCE
- Samsung Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

- Global Sourcing Solution
- Obsolete Management
- Cost Control Management
- Shortage Management
- Alternative Solution
- Excess Inventory Management